# AP0704GMT-HF-VB Datasheet

## N-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY | | | |
|---|---|---|---|
| $V_{DS}$ (V) | $R_{DS(on)}$ (Ω) | $I_D$ (A)[a, e] | $Q_g$ (Typ.) |
| 40 | 0.0050 at $V_{GS}$ = 10 V | 70 | 67 nC |
| | 0.0060 at $V_{GS}$ = 4.5 V | 65 | |

### FEATURES

- Trench Power MOSFET
- 100 % $R_g$ and UIS Tested

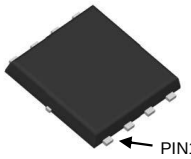
RoHS COMPLIANT

### APPLICATIONS

- Notebook PC Core
- VRM/POL

DFN5X6

Top View

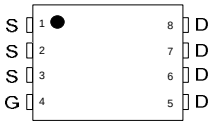


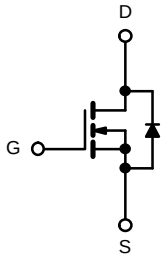
Bottom View



PIN1

Top View




N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_A$ = 25 °C, unless otherwise noted) | | | | |
|---|---|---|---|---|
| **Parameter** | | **Symbol** | **Limit** | **Unit** |
| Drain-Source Voltage | | $V_{DS}$ | 40 | V |
| Gate-Source Voltage | | $V_{GS}$ | ± 20 | |
| Continuous Drain Current ($T_J$ = 175 °C) | $T_C$ = 25 °C | $I_D$ | 70[a, e] | A |
| | $T_C$ = 70 °C | | 60[e] | |
| | $T_A$ = 25 °C | | 19[b, c] | |
| | $T_A$ = 70 °C | | 18.6[b, c] | |
| Pulsed Drain Current | | $I_{DM}$ | 120 | |
| Avalanche Current Pulse | L = 0.1 mH | $I_{AS}$ | 21 | |
| Single Pulse Avalanche Energy | | $E_{AS}$ | 47.2 | mJ |
| Continuous Source-Drain Diode Current | $T_C$ = 25 °C | $I_S$ | 70[a, e] | A |
| | $T_A$ = 25 °C | | 2.36[b, c] | |
| Maximum Power Dissipation | $T_C$ = 25 °C | $P_D$ | 100[a] | W |
| | $T_C$ = 70 °C | | 55 | |
| | $T_A$ = 25 °C | | 6.15[b, c] | |
| | $T_A$ = 70 °C | | 3.07[b, c] | |
| Operating Junction and Storage Temperature Range | | $T_J$, $T_{stg}$ | - 55 to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|---|---|---|---|---|
| **Parameter** | | **Symbol** | **Typical** | **Maximum** | **Unit** |
| Maximum Junction-to-Ambient[b, d] | t ≤ 10 s | $R_{thJA}$ | 47 | 56 | °C/W |
| Maximum Junction-to-Case | Steady State | $R_{thJC}$ | 0.8 | 1.1 | |

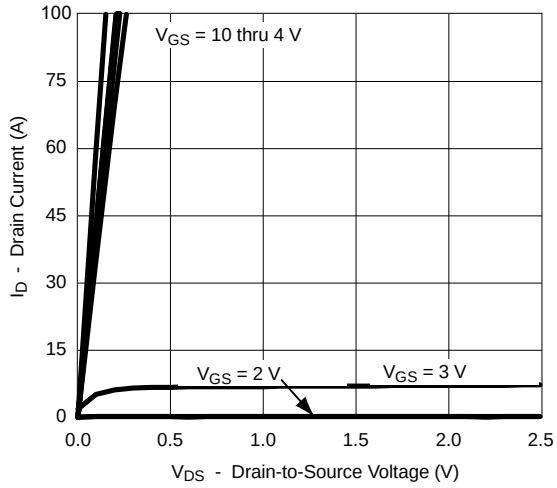
Notes:
a. Based on $T_C$ = 25 °C.
b. Surface mounted on 1" x 1" FR4 board.
c. t = 10 s.
d. Maximum under steady state conditions is 90 °C/W.
e. Calculated based on maximum junction temperature. Package limitation current is 80 A.

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **Parameter** | **Symbol** | **Test Conditions** | **Min .** | **Typ.** | **Max.** | **Unit** |
| **Static** | | | | | | |
| Drain-Source Breakdown Voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | 40 | | | V |
| $V_{DS}$ Temperature Coefficient | $\Delta V_{DS}/T_J$ | $I_D$ = 250 µA | | 35 | | mV/°C |
| $V_{GS(th)}$ Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | - 5.5 | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | 1.2 | | 2.5 | V |
| Gate-Source Leakage | $I_{GSS}$ | $V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 40 V, $V_{GS}$ = 0 V | | | 1 | µA |
| | | $V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C | | | 10 | |
| On-State Drain Current[a] | $I_{D(on)}$ | $V_{DS} \geq$ 5 V, $V_{GS}$ = 10 V | 70 | | | A |
| Drain-Source On-State Resistance[a] | $R_{DS(on)}$ | $V_{GS}$ = 10 V, $I_D$ = 32 A | | 0.005 | | Ω |
| | | $V_{GS}$ = 4.5 V, $I_D$ = 29 A | | 0.006 | | |
| Forward Transconductance[a] | $g_{fs}$ | $V_{DS}$ = 15 V, $I_D$ = 32 A | | 110 | | S |
| **Dynamic[b]** | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{DS}$= 12.5 V, $V_{GS}$ = 0 V, f = 1 MHz | | 1195 | | pF |
| Output Capacitance | $C_{oss}$ | | | 975 | | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | 670 | | |
| Total Gate Charge | $Q_g$ | $V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_D$ = 32 A | | 67 | | nC |
| | | $V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_D$ = 29 A | | 57.3 | | |
| Gate-Source Charge | $Q_{gs}$ | | | 31 | | |
| Gate-Drain Charge | $Q_{gd}$ | | | 25 | | |
| Gate Resistance | $R_g$ | f = 1 MHz | | 1.4 | 2.1 | Ω |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}$ = 15 V, $R_L$ = 0.555 Ω<br>$I_D \cong$ 27 A, $V_{GEN}$ = 10 V, $R_g$ = 1 Ω | | 18 | 27 | ns |
| Rise Time | $t_r$ | | | 11 | 17 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 70 | 105 | |
| Fall Time | $t_f$ | | | 10 | 15 | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD}$ = 15 V, $R_L$ = 0.625 Ω<br>$I_D \cong$ 24 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 Ω | | 55 | 83 | |
| Rise Time | $t_r$ | | | 180 | 270 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 55 | 83 | |
| Fall Time | $t_f$ | | | 12 | 18 | |
| **Drain-Source Body Diode Characteristics** | | | | | | |
| Continuous Source-Drain Diode Current | $I_S$ | $T_C$ = 25 °C | | | 70 | A |
| Pulse Diode Forward Current[a] | $I_{SM}$ | | | | 100 | |
| Body Diode Voltage | $V_{SD}$ | $I_S$ = 22 A | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | $t_{rr}$ | $I_F$ = 20 A, di/dt = 100 A/µs, $T_J$ = 25 °C | | 52 | 78 | ns |
| Body Diode Reverse Recovery Charge | $Q_{rr}$ | | | 70.2 | 105 | nC |
| Reverse Recovery Fall Time | $t_a$ | | | 27 | | ns |
| Reverse Recovery Rise Time | $t_b$ | | | 25 | | |

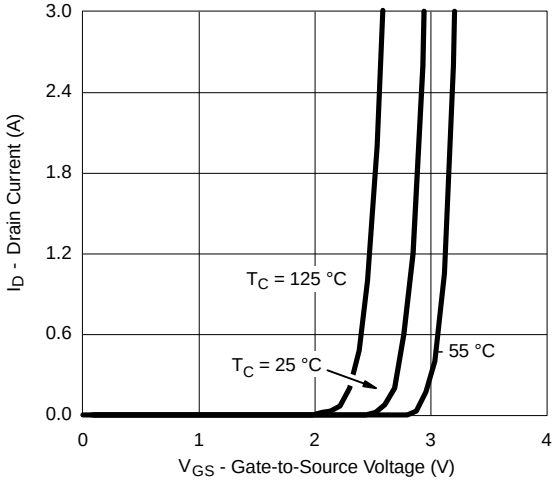
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

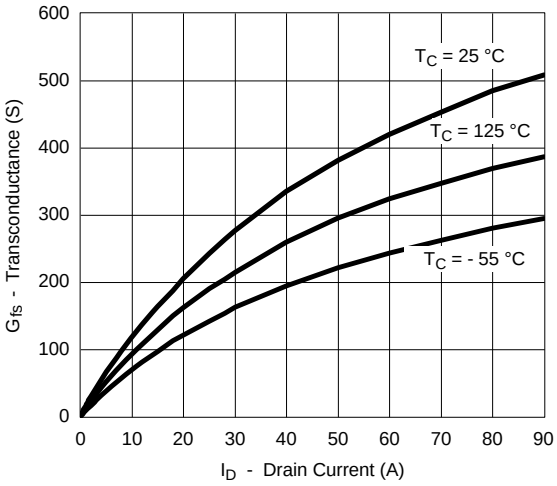
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



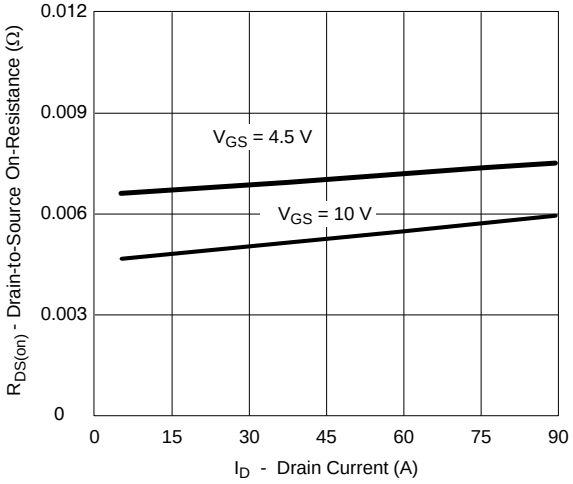

**Output Characteristics**



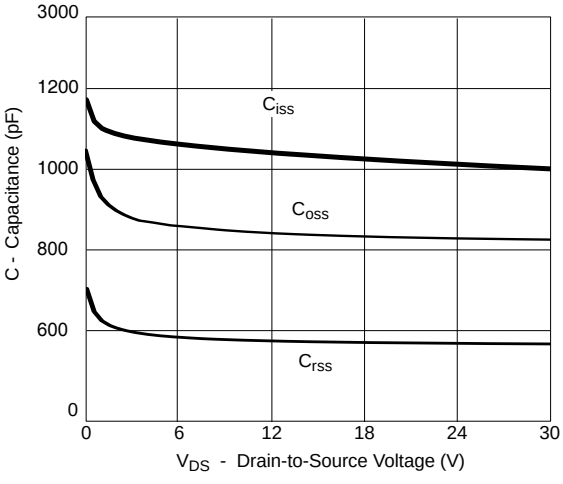

**Transfer Characteristics**



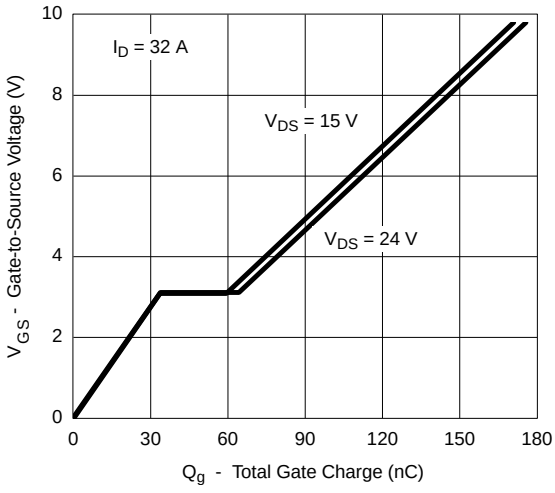

**Transconductance**




**$R_{DS(on)}$ vs. Drain Current**

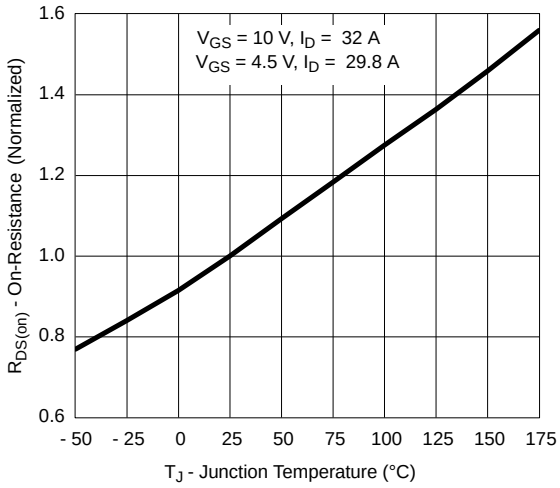



**Capacitance**

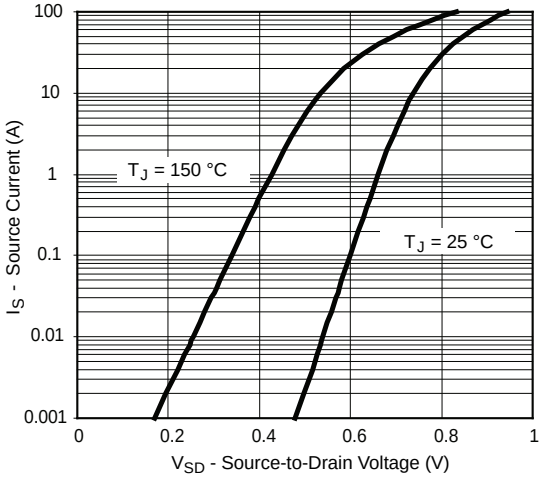



**Gate Charge**

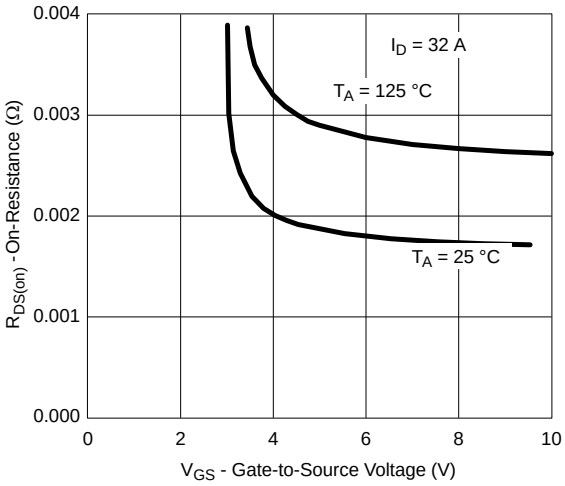
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



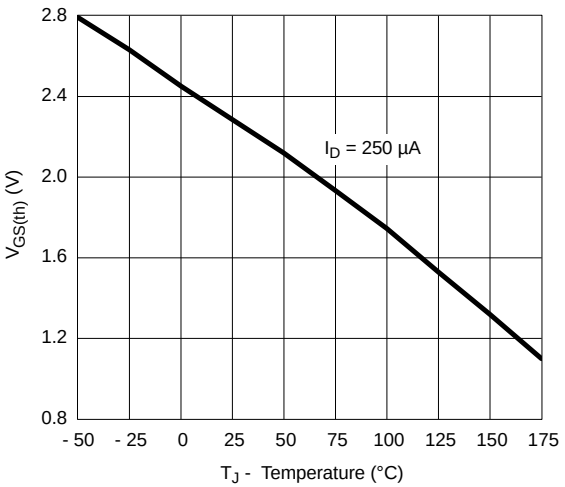

**On-Resistance vs. Junction Temperature**



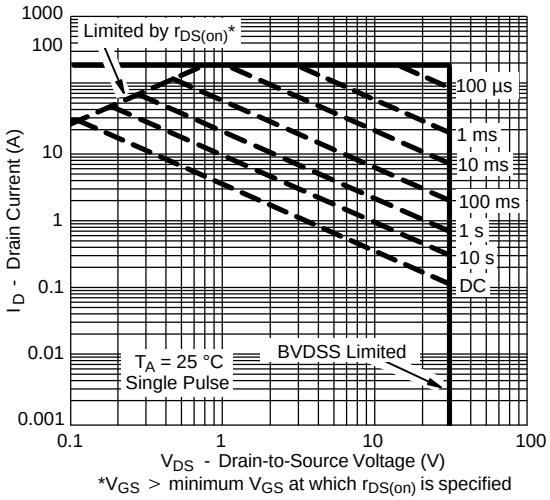

**Forward Diode Voltage vs. Temperature**




**$R_{DS(on)}$ vs. $V_{GS}$ vs. Temperature**



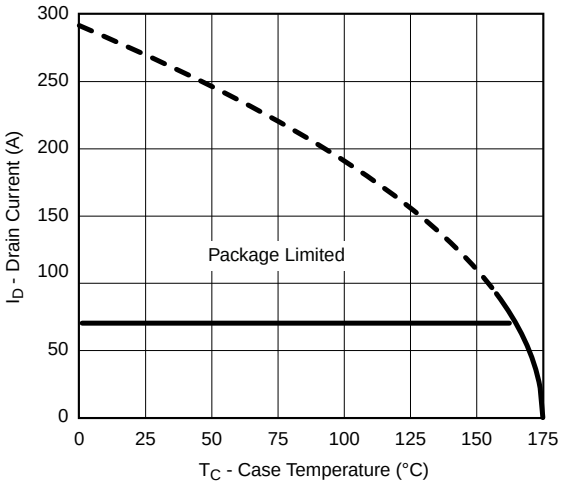

**Threshold Voltage**



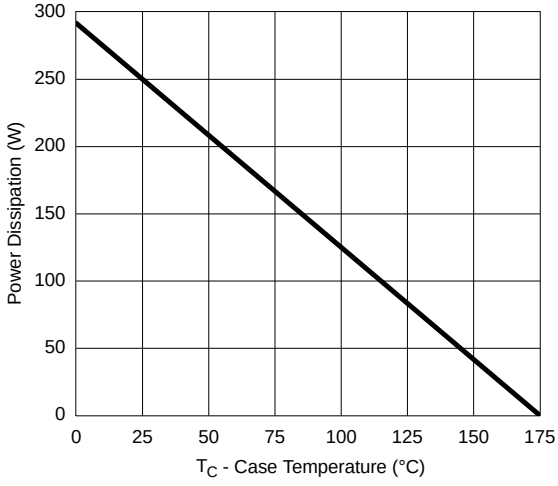

*$V_{GS}$ > minimum $V_{GS}$ at which $r_{DS(on)}$ is specified

**Safe Operating Area, Junction-to-Ambient**

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

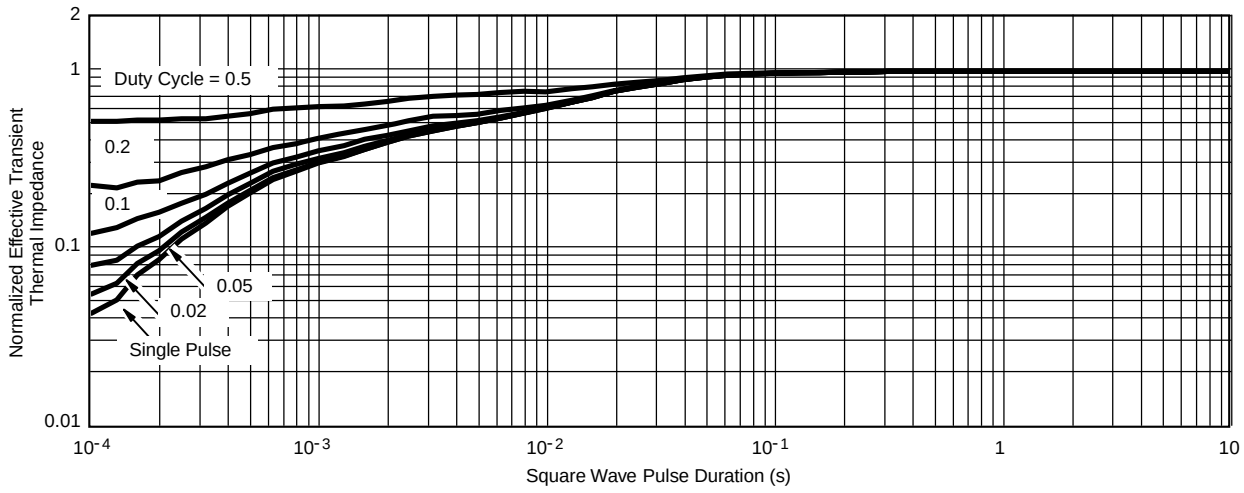



**Current Derating***



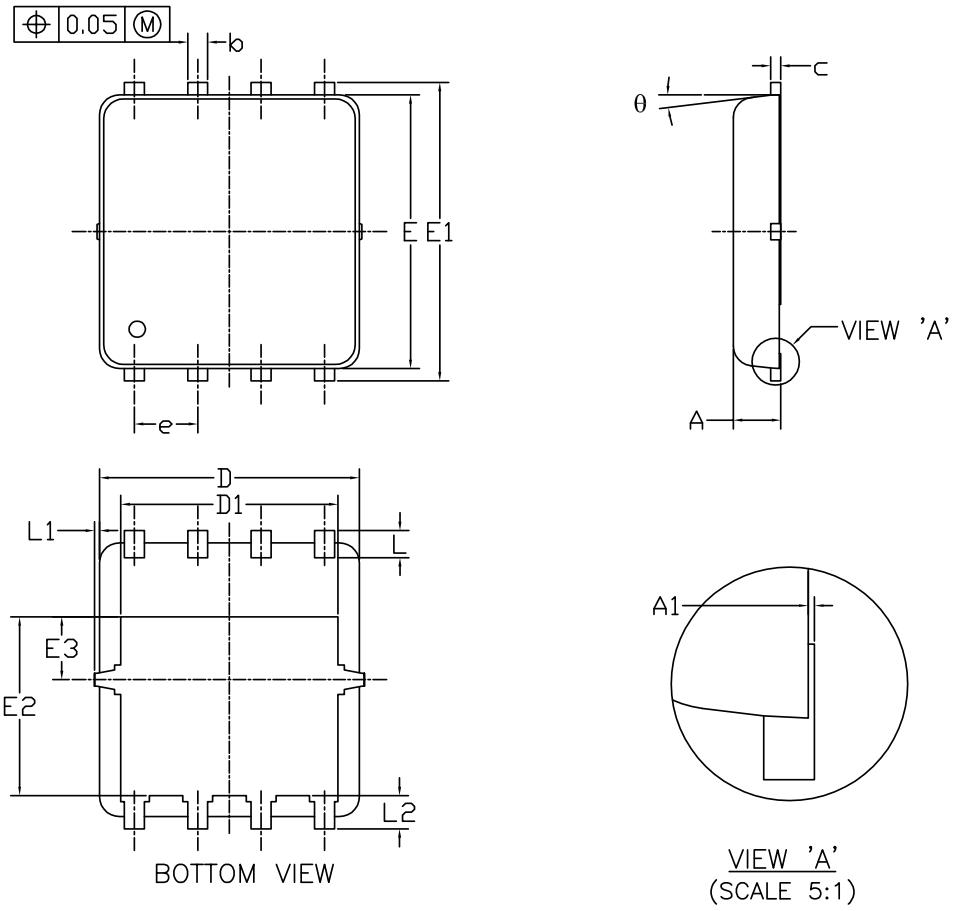

**Power Derating**

* The power dissipation $P_D$ is based on $T_{J(max)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

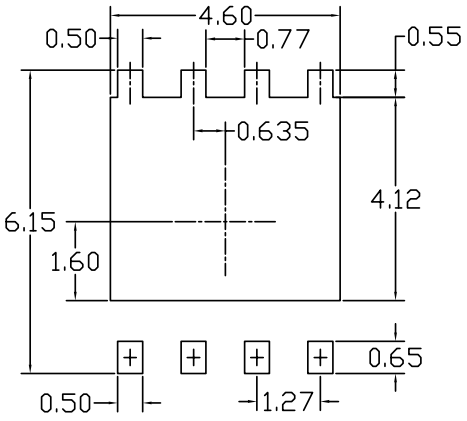



**Normalized Thermal Transient Impedance, Junction-to-Case**

## DFN5x6_8L_EP1_P PACKAGE OUTLIN




RECOMMENDED LAND PATTERN




| SYMBOLS | DIMENSIONS IN MILLIMETERS | | | DIMENSIONS IN INCHES | | |
|---|---|---|---|---|---|---|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.85 | 0.95 | 1.00 | 0.033 | 0.037 | 0.039 |
| A1 | 0.00 | --- | 0.05 | 0.000 | --- | 0.002 |
| b | 0.30 | 0.40 | 0.50 | 0.012 | 0.016 | 0.020 |
| c | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 5.10 | 5.20 | 5.30 | 0.201 | 0.205 | 0.209 |
| D1 | 4.25 | 4.35 | 4.45 | 0.167 | 0.171 | 0.175 |
| E | 5.45 | 5.55 | 5.65 | 0.215 | 0.219 | 0.222 |
| E1 | 5.95 | 6.05 | 6.15 | 0.234 | 0.238 | 0.242 |
| E2 | 3.525 | 3.625 | 3.725 | 0.139 | 0.143 | 0.147 |
| E3 | 1.175 | 1.275 | 1.375 | 0.046 | 0.050 | 0.054 |
| e | 1.27 BSC | | | 0.050 BSC | | |
| L | 0.45 | 0.55 | 0.65 | 0.018 | 0.022 | 0.026 |
| L1 | 0 | --- | 0.15 | 0 | --- | 0.006 |
| L2 | 0.68 REF | | | 0.027 REF | | |
| θ | 0° | --- | 10° | 0° | --- | 10° |

UNIT: mm

NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
   MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
2. CONTROLLING DIMENSION IS MILLIMETER.
   CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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